

S/N 09/470,265

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Karl M. Robinson

Examiner: Cuong Q Nguyen

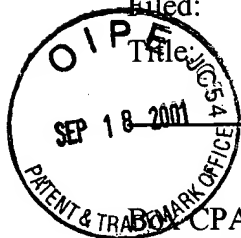
Serial No.: 09/470,265

Group Art Unit: 2811

Filed: December 22, 1999

Docket: 303.455US3

Title: DEVICES HAVING IMPROVED CAPACITANCE AND METHODS OF THEIR FABRICATION



INFORMATION DISCLOSURE STATEMENT

Box CPA

Commissioner for Patents
Washington, D.C. 20231

#14
Prior Art
FJONES
10-17-01

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 *et. seq.*, the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicant respectfully requests that this Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicant further request that a copy of the 1449 form, initialled by the Examiner to indicate that all listed citations have been considered, be returned with the next official communication.

Under 37 C.F.R. §1.97(b)(3), it is believed that no fee or certificate is required with this Information Disclosure Statement. However, the Commissioner is hereby authorized to charge any additional fees or credit any overpayment to Account No. 19-0743.

The Examiner is invited to contact the Applicant's Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

KARL M. ROBINSON

By his Representatives,

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Date

9/18/2001

By

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This paper or fee is being deposited on the date indicated above with the United States Postal Service pursuant to 37 CFR 1.10, and is addressed to Box CPA, Commissioner for Patents, Washington, D. C. 20231.